



- Microsemi Scottsdale will provide our full portfolio of plastic and hermetic devices as RoHS compliant.
- RoHS compliant part numbers will be identified by an "e#" suffix in the part number where the designator will indicate the Pb-free 2nd level interconnect terminal finish categories that are defined in JESD97: Example: SMBJ5.0CAe3 (plastic) or 1N751Ae3 (hermetic).
- Part marking will be as identified on the device data sheet.
- RoHS compliant termination plating will be annealed matte tin.
- RoHS compliance will include, where required, the applicable exemptions which allow for lead (Pb) content in glass and also high temperature lead (Pb) based solders used for internal die attach.
- All intermediate packaging will be appropriately labeled to identify RoHS compliance.
- Microsemi Scottsdale will continue to provide all plastic and hermetic devices with standard Tin/Lead(Sn/Pb) final finish on terminations per current data sheets. No parts will be obsoleted.
- Microsemi Scottsdale will continue to support all QPL products per the applicable slash sheet. Products marked with any "JAN" designation will **not** be available as RoHS compliant.
- Microsemi Scottsdale is accepting orders now for RoHS compliant products.